

As a below-named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention titled:

SEMICONDUCTOR MULTI-PACKAGE MODULE HAVING INVERTED SECOND PACKAGE AND INCLUDING ADDITIONAL DIE OR STACKED PACKAGE ON SECOND PACKAGE

the specifica	tion of which	•			
is attached hereto.					
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[and was amended on (<i>if applicable</i>).				
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.					
I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a) which states in relevant part: "Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this sectionThe duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§ 1.97(b)-(d) and 1.98."					
I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate as indicated below and have also identified below any foreign application for patent or inventor's certificate on this invention having a filing date before that of the application on which priority is claimed:					
• •	,				
	Foreign Application	n(s) _.		Priority Claimed	d .
Prior	Foreign Application			Priority Claimed ☐ Yes	d No
Prior	Foreign Application	n(s) _. Day/Month/Year Filed)		Yes	□ No
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I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith, and to file, prosecute and to transact all business in connection with international applications directed to said invention:

Mark A. Haynes	Reg. No. 30,846
Ernest J. Beffel, Jr.	Reg. No. 43,489
Warren S. Wolfeld	Reg. No. 31,454
James F. Hann	Reg. No. 29,719
Bill Kennedy	Reg. No. 33,407

Address all correspondence to:

CUSTOMER NO. 22470

Bill Kennedy Haynes Beffel & Wolfeld LLP P.O. Box 366 Half Moon Bay, CA 94019

Direct all telephone calls to Bill Kennedy at (650) 712-0340.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor:

Inventor's signature:

Date:

Citizenship:

Marcos Karnezos

U.S.A.

Mailing Address:

535 Lytton Avenue

Palo Alto, CA 94301

Residence:

Same as above